



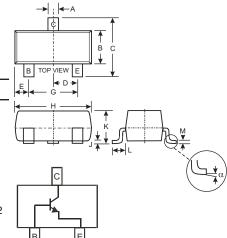
NPN SMALL SIGNAL SURFACE MOUNT TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Complementary PNP Type Available (MMBT3906)
- Ideal for Medium Power Amplification and Switching
- Lead Free/RoHS Compliant (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT-23
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Marking (See Page 2): K1N
- Ordering & Date Code Information: See Page 2
- Weight: 0.008 grams (approximate)



SOT-23								
Dim								
Α	0.37	0.51						
В	1.20	1.40						
С	2.30	2.50						
D	0.89	1.03						
Е	0.45	0.60						
G	1.78	2.05						
Н	2.80	3.00						
J	0.013	0.10						
K	0.903	1.10						
L	0.45	0.61						
M	0.085	0.180						
α	0°	8°						
All Dimensions in mm								

@ $T_A = 25$ °C unless otherwise specified **Maximum Ratings**

Characteristic	Symbol	MMBT3904	Unit
Collector-Base Voltage	V _{CBO}	60	V
Collector-Emitter Voltage	V _{CEO}	40	V
Emitter-Base Voltage	V _{EBO}	6.0	V
Collector Current - Continuous (Note 1)	Ic	200	mA
Power Dissipation (Note 1)	Pd	300	mW
Thermal Resistance, Junction to Ambient (Note 1)	R ₀ JA	417	°C/W
Operating and Storage and Temperature Range	T _j , T _{STG}	-55 to +150	°C

Notes:

- 1. Device mounted on FR-5 PCB 1.0 x 0.75 x 0.062 inch pad layout as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 2. No purposefully added lead.



Electrical Characteristics @ T_A = 25°C unless otherwise specified

Base Cutoff Current IBL — 50 nA VcE = 30V, VEB(OFF) = 3.0V ON CHARACTERISTICS (Note 3) IC = 100μA, VCE = 1.0V	Characteristic	Symbol	Min	Max	Unit	Test Condition
Collector-Emitter Breakdown Voltage $V_{(BR)CEO}$ 40 — V Ic = 1.0mA, I _B = 0 Emitter-Base Breakdown Voltage $V_{(BR)EBO}$ 6.0 — V I _E = 10μA, I _C = 0 Collector Cutoff Current I _{CEX} — 50 nA V _{CE} = 30V, V _{EB(OFF)} = 3.0V Base Cutoff Current I _{BL} — 50 nA V _{CE} = 30V, V _{EB(OFF)} = 3.0V ON CHARACTERISTICS (Note 3) To a second of the second o	CHARACTERISTICS (Note 3)					
Emitter-Base Breakdown Voltage V(BR)EBO 6.0 — V IE = 10μA, IC = 0	ector-Base Breakdown Voltage	V _{(BR)CBO}	60	_	V	$I_C = 10\mu A, I_E = 0$
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	ector-Emitter Breakdown Voltage	V _{(BR)CEO}	40	_	V	$I_C = 1.0 \text{mA}, I_B = 0$
Base Cutoff Current IBL — 50 nA V _{CE} = 30V, V _{EB(OFF)} = 3.0V ON CHARACTERISTICS (Note 3) IC 100 - IC 100µA, V _{CE} = 1.0V IC 1.0V	ter-Base Breakdown Voltage	V _{(BR)EBO}	6.0	_	V	$I_E = 10 \mu A, I_C = 0$
ON CHARACTERISTICS (Note 3) DC Current Gain $A0$ 70 70 70 70 10 10 10 10 10 10 10 10 10 10 10 10 10	ector Cutoff Current	I _{CEX}	_	50	nA	$V_{CE} = 30V$, $V_{EB(OFF)} = 3.0V$
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Cutoff Current	I _{BL}	_	50	nA	$V_{CE} = 30V$, $V_{EB(OFF)} = 3.0V$
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	CHARACTERISTICS (Note 3)					
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Current Gain	h _{FE}	70 100 60		_	I _C = 1.0mA, V _{CE} = 1.0V I _C = 10mA, V _{CE} = 1.0V I _C = 50mA, V _{CE} = 1.0V
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	ector-Emitter Saturation Voltage	V _{CE(SAT)}	_		V	
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Emitter Saturation Voltage	V _{BE(SAT)}	0.65		V	
Input Capacitance C_{ibo} — 8.0 pF $V_{EB} = 0.5V$, $f = 1.0MHz$, Ic Input Impedance h_{ie} 1.0 10 $k\Omega$	LL SIGNAL CHARACTERISTICS				•	
Input Impedance h_{ie} 1.0 10 $k\Omega$	ut Capacitance	C _{obo}	_	4.0	pF	$V_{CB} = 5.0V$, $f = 1.0MHz$, $I_E = 0$
Welling Footback Patte	Capacitance	C _{ibo}	_	8.0	pF	$V_{EB} = 0.5V$, $f = 1.0MHz$, $I_{C} = 0$
Williams Familiands Datio	Impedance	h _{ie}	1.0	10	kΩ	
Voltage Feedback Ratio $h_{re} = 0.5$ 8.0 $\times 10^{-4}$ $V_{CE} = 10V$, $I_{C} = 1.0$ mA,	age Feedback Ratio	h _{re}	0.5	8.0	x 10 ⁻⁴	V _{CE} = 10V, I _C = 1.0mA,
Small Signal Current Gain	Il Signal Current Gain	h _{fe}	100	400	_	f = 1.0kHz
Output Admittance h _{oe} 1.0 40 μS	ut Admittance	h _{oe}	1.0	40	μS	
Current Gain-Bandwidth Product f_T 300 — MHz $V_{CE} = 20V$, $I_C = 10$ mA, $f = 10$ 0MHz	ent Gain-Bandwidth Product	f _T	300	_	MHz	
Noise Figure NF $-$ 5.0 dB $V_{CE} = 5.0V$, $I_{C} = 100 \mu A$, $R_{S} = 1.0 k \Omega$, $f = 1.0 k Hz$	e Figure	NF	_	5.0	dB	
SWITCHING CHARACTERISTICS	CHING CHARACTERISTICS					
Delay Time t_d — 35 ns $V_{CC} = 3.0V$, $I_C = 10 mA$,	y Time	t _d	_	35	ns	
Rise Time t_r — 35 ns $V_{BE(off)} = -0.5V$, $I_{B1} = 1.0m$	Time	t _r	_	35	ns	$V_{BE(off)} = -0.5V, I_{B1} = 1.0mA$
Storage Time t_s — 200 ns $V_{CC} = 3.0V$, $I_C = 10 \text{mA}$,	age Time	ts	_	200	ns	V _{CC} = 3.0V, I _C = 10mA,
Fall Time $ t_{\rm f} - 50 \text{ns} I_{\rm B1} = I_{\rm B2} = 1.0 \text{mA} $	 Fime	t _f		50	ns	$I_{B1} = I_{B2} = 1.0 \text{mA}$

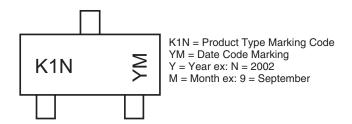
Ordering Information (Note 4)

Device	Packaging	Shipping
MMBT3904-7-F	SOT-23	3000/Tape & Reel

Notes:

- 3. Short duration test pulse used to minimize self-heating effect.
- 4. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

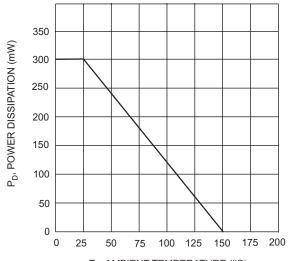
Marking Information



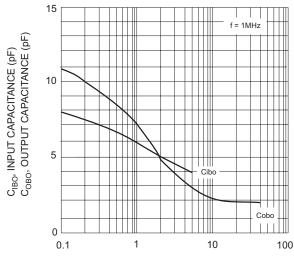
Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009
Code	J	K	L	М	N	Р	R	S	Т	U	V	W
Month	Jan	Feb	March	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec

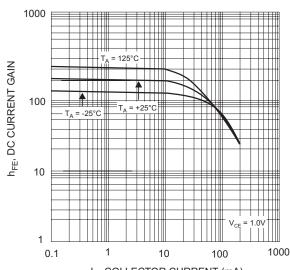




T_A, AMBIENT TEMPERATURE (°C) Fig. 1, Max Power Dissipation vs Ambient Temperature



V_{CB}, COLLECTOR-BASE VOLTAGE (V) Fig. 2, Input and Output Capacitance vs. Collector-Base Voltage



I_C, COLLECTOR CURRENT (mA) Fig. 3, Typical DC Current Gain vs Collector Current

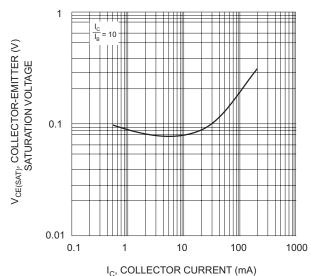
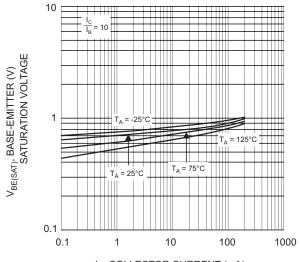


Fig. 4, Typical Collector-Emitter
Saturation Voltage vs. Collector Current



I_C, COLLECTOR CURRENT (mA) Fig. 5, Typical Base-Emitter Saturation Voltage vs. Collector Current



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